

APPLICATION DATA SHEET**Inventor Information**

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Application Information

Title : SYSTEMS FOR MAKING AND USING BI-MODAL
 ABRASIVE SLURRIES FOR MECHANICAL AND
 CHEMICAL-MECHANICAL PLANARIZATION OF
 MICROELECTRONIC-DEVICE SUBSTRATE
 ASSEMBLIES
 Total Drawing Sheets : 5
 Formal Drawings : YES
 Application Type : Utility 155.06
 Attorney Docket Number : 500155.06
 Assigned : Yes (Large Entity)

Representative Information

Representative Customer No. : 27,076

Continuity Information

This application is a : divisional of

>Application One : 10/155,203
Filing Date : May 23, 2002
which is a : continuation of
>>Application Two : 09/289,790
Filing Date : April 9, 1999
Patent Number : 6,407,000

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